

MOSFET

OptiMOS[™] 5 Power-Transistor, 30 V

Features

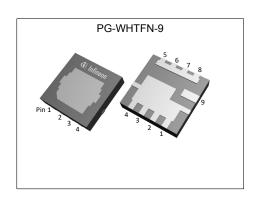
- Very low on-resistance $R_{\text{DS(on)}}$ @ V $_{\text{GS}}$ =4.5 V • 100% avalanche tested
- Superior thermal resistance
- N-channel, logic level
- Optimized for high performance SMPS, e.g. sync.rec.
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

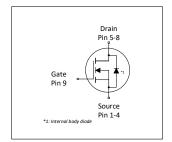


Fully qualified according to JEDEC for Industrial Applications

Table 1 **Kev Performance Parameters**

Table 1 Hoj 1 dillollinando 1 anamotoro							
Parameter	Value	Unit					
V _{DS}	30	V					
$R_{\mathrm{DS(on),max}}$	0.85	mΩ					
I_{D}	252	A					
Qoss	31	nC					
Q _G (0V4.5V)	30	nC					











Type / Ordering Code	Package	Marking	Related Links
IQE008N03LM5CGSC	PG-WHTFN-9	L	-

OptiMOS[™] 5 Power-Transistor, 30 V





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OptiMOS[™] 5 Power-Transistor, 30 V IQE008N03LM5CGSC



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Damamatan	Oh a l	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	252 159 147 38	A	V _{GS} =10 V, T _C =25 °C V _{GS} =10 V, T _C =100 °C V _{GS} =4.5 V, T _C =100 °C V _{GS} =10 V,T _A =25°C,R _{thJA} =60°C/W ²)
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1008	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	50	mJ	I_D =20 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-16	-	16	V	-
Power dissipation	P _{tot}	-	-	89 2.1	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	-

2 Thermal characteristics

Table 3 Thermal characteristics

Darameter	Symbol	Values			Unit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Oilit	Note / Test Condition	
Thermal resistance, junction - case, bottom	R _{thJC}	-	-	1.4	°C/W	-	
Thermal resistance, junction - case, top	R _{thJC}	-	0.7	-	°C/W	-	
Thermal resistance, junction - ambient, 6 cm² cooling area ²⁾	R _{thJA}	-	-	60	°C/W	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

OptiMOS[™] 5 Power-Transistor, 30 V IQE008N03LM5CGSC



3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	0		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	30	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.2	1.6	2.0	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 250 \ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1.0 100	μΑ	V _{DS} =24 V, V _{GS} =0 V, T _j =25 °C V _{DS} =24 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	0.65 0.80	0.85 1.0	mΩ	V _{GS} =10 V, I _D =20 A V _{GS} =4.5 V, I _D =20 A
Gate resistance	R _G	-	0.7	-	Ω	-
Transconductance	g fs	-	190	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 20 A$

Table 5 Dynamic characteristics

Davamatav	Complete	Values			11	Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	4400	5700	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	1100	1400	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	110	190	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	19	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	38	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	32	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	9.3	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Parameter	Values			s	11:4:4	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	10	-	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge at threshold	$Q_{g(th)}$	-	7.0	-	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	6.0	9	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Switching charge	Q _{sw}	-	9.1	-	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ¹⁾	Q g	-	30	38	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.3	-	V	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total	Q g	-	64	-	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	28	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 4.5 V
Output charge ¹⁾	Qoss	-	31	41	nC	V _{DS} =15 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

OptiMOSTM 5 Power-Transistor, 30 V

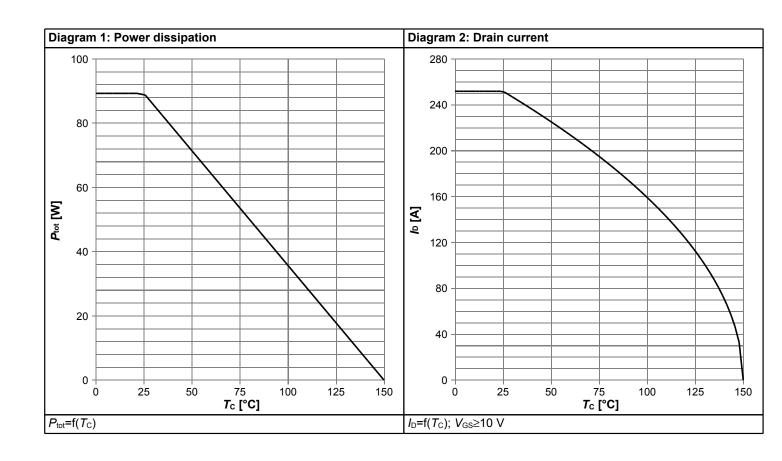


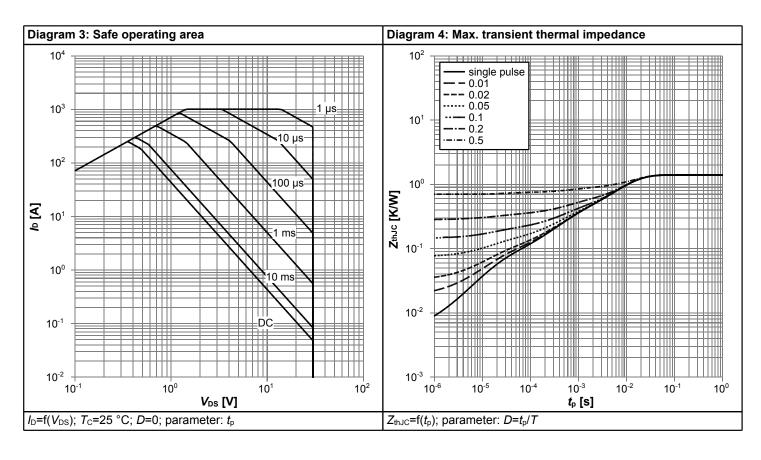
Table 7 Reverse diode

Parameter	Symbol		Values			Nata / Tant Candition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	81	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	1008	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.73	1.0	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	34	68	ns	V _R =15 V, I _F =20 A, di _F /dt=100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	27	54	nC	V_R =15 V, I_F =20 A, di_F/dt =100 A/ μ s

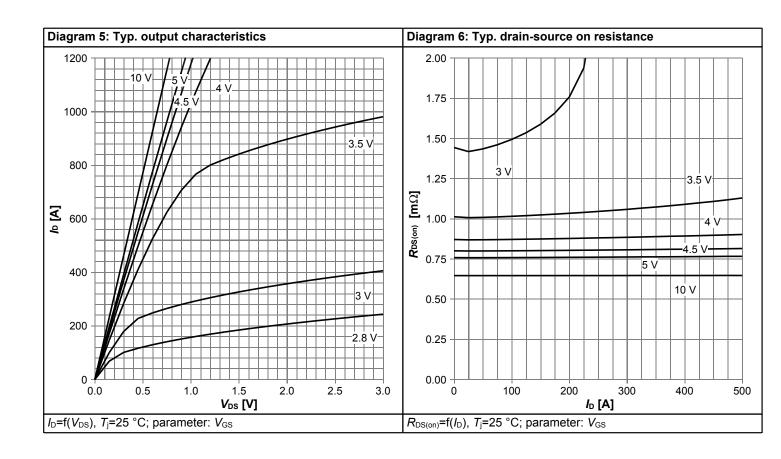


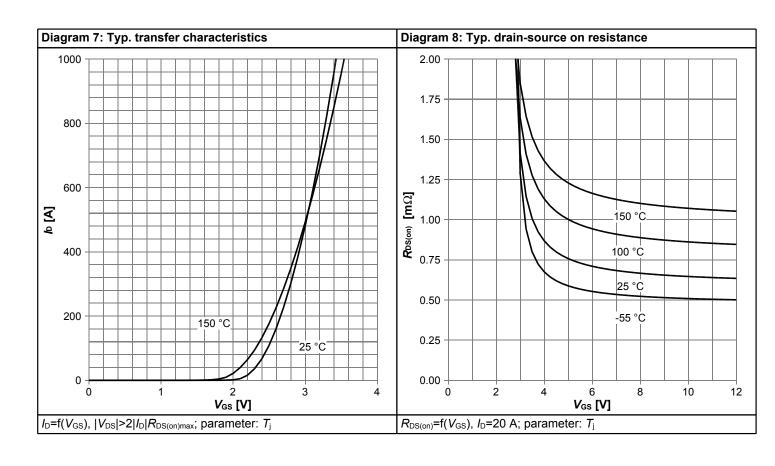
4 Electrical characteristics diagrams



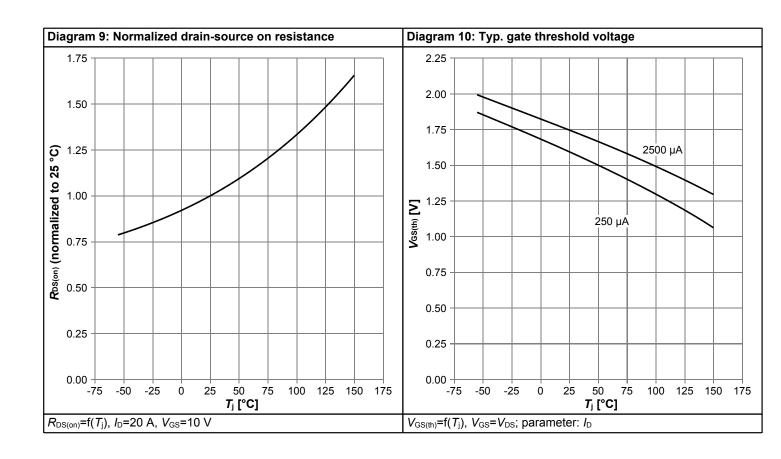


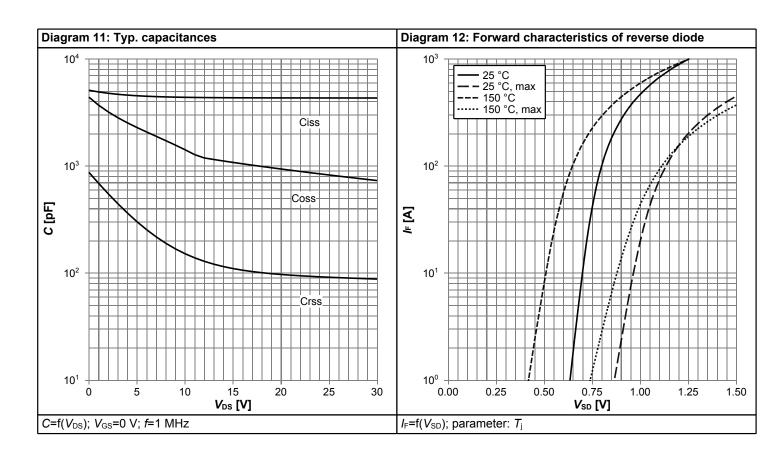




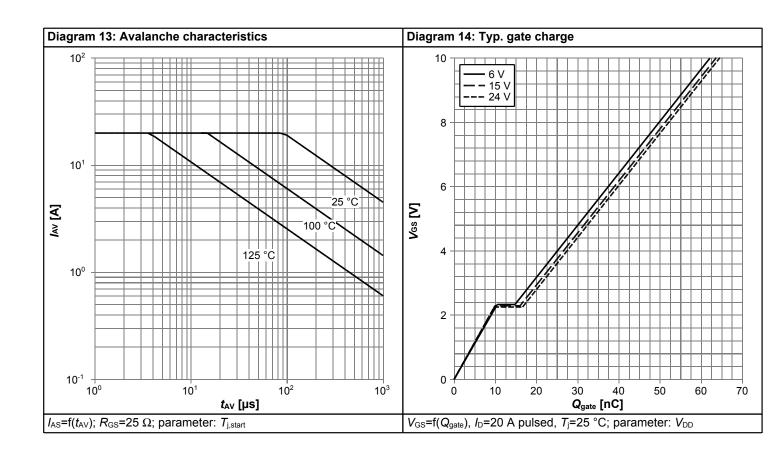


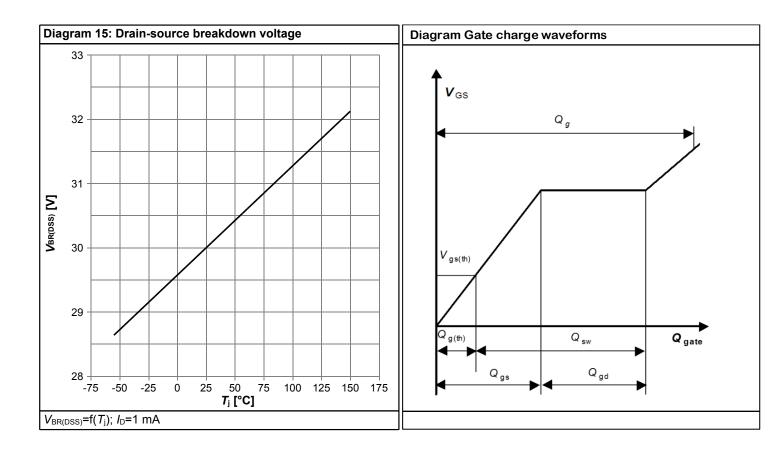














5 Package Outlines

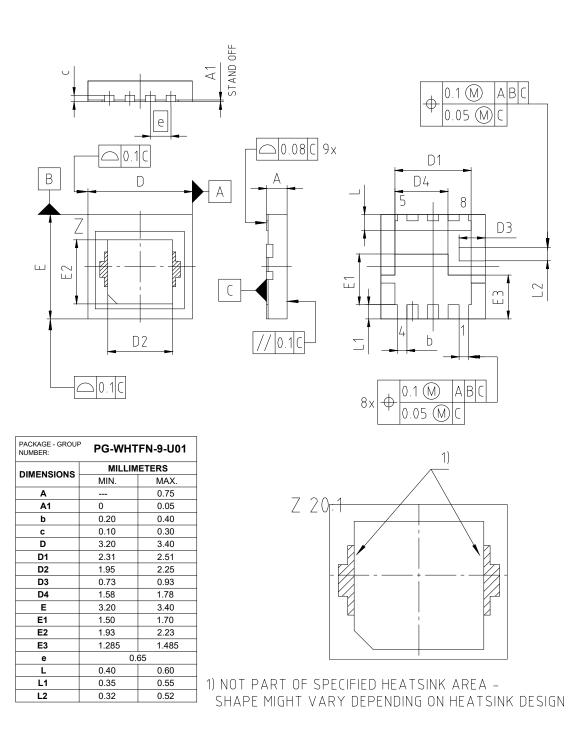
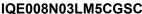


Figure 1 Outline PG-WHTFN-9, dimensions in mm

OptiMOS[™] 5 Power-Transistor, 30 V





Revision History

IQE008N03LM5CGSC

Revision: 2023-03-29, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)				
2.0	2023-03-29	Release of final version				

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Final Data Sheet 11 Rev. 2.0, 2023-03-29